

IGBT

SGH30N60RUF

Short Circuit Rated IGBT

General Description

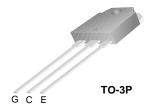
Fairchild's RUF series of Insulated Gate Bipolar Transistors (IGBTs) provide low conduction and switching losses as well as short circuit ruggedness. The RUF series is designed for applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short circuit ruggedness is a required feature.

Features

- Short circuit rated 10us @ $T_C = 100$ °C, $V_{GE} = 15$ V
- · High speed switching
- Low saturation voltage : $V_{CE(sat)} = 2.2 \text{ V} @ I_C = 30 \text{A}$
- High input impedance

Applications

AC & DC motor controls, general purpose inverters, robotics, and servo controls.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		SGH30N60RUF	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
	Collector Current	@ T _C = 25°C	48	А
IC	Collector Current	@ T _C = 100°C	30	А
I _{CM (1)}	Pulsed Collector Current		90	А
	Short Circuit Withstand Time	@ T _C =100°C	10	us
P _D	Maximum Power Dissipation	@ T _C = 25°C	235	W
	Maximum Power Dissipation	@ T _C = 100°C	90	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

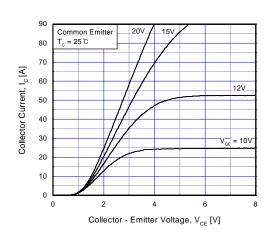
Notes:

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.53	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	600			V
$\Delta B_{VCES}/$ ΔT_J	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V$, $I_C = 1mA$		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Chai	racteristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 30$ mA, $V_{CE} = V_{GE}$	5.0	6.0	8.5	V
	Collector to Emitter	$I_C = 30A$, $V_{GF} = 15V$		2.2	2.8	V
$V_{CE(sat)}$	Saturation Voltage	$I_C = 48A$, $V_{GE} = 15V$		2.5		V
Dynami	c Characteristics	, <u> </u>		1		
C _{ies}	Input Capacitance			1970		pF
C _{oes}	Output Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$		310		pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz		74		pF
t _{d(on)}	ng Characteristics Turn-On Delay Time			30		ns
t _r	Rise Time	-		65		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 30\text{A},$		54	80	ns
<u>t_f (οπ)</u>	Fall Time	$R_G = 7\Omega, V_{GE} = 15V,$		138	200	ns
E _{on}	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$		919		uJ
E _{off}	Turn-Off Switching Loss	_		814		uJ
E _{ts}	Total Switching Loss			1733	2430	uJ
t _{d(on)}	Turn-On Delay Time			34		ns
t _r	Rise Time			67		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 30\text{A},$		60	90	ns
t _f	Fall Time	$R_G = 7\Omega$, $V_{GE} = 15V$,		281	400	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C		921		uJ
E _{off}	Turn-Off Switching Loss	1		1556		uJ
E _{ts}	Total Switching Loss	1		2477	3470	uJ
T _{sc}	Short Circuit Withstand Time	V _{CC} = 300 V, V _{GE} = 15V @ T _C = 100°C	10			us
Q _a	Total Gate Charge	-		85	120	nC
Q _{ge}	Gate-Emitter Charge	$V_{CE} = 300 \text{ V}, I_{C} = 30\text{A},$		17	25	nC
∽ae						
Q _{gc}	Gate-Collector Charge	V _{GE} = 15V		39	55	nC



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Common Emitter

 $V_{GE} = 15V$ $T_{C} = 25^{\circ}C$

80

70

60

50

40

30

20

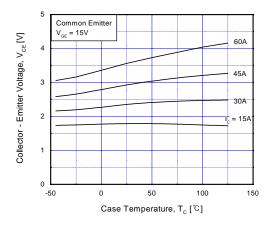
Collector Current, I_c [A]

Fig 1. Typical Output Characteristics

Fig 2. Typical Saturation Voltage Characteristics

Collector - Emitter Voltage, V_{CE} [V]

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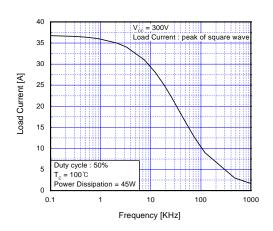
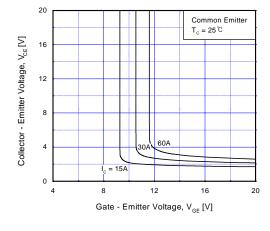


Fig 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

Fig 4. Load Current vs. Frequency



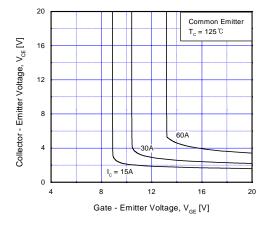
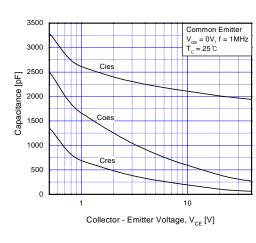


Fig 5. Saturation Voltage vs. V_{GE}

Fig 6. Saturation Voltage vs. $V_{\rm GE}$

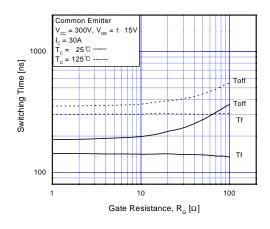
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Common Emitter $V_{\rm Cc} = 300V, V_{\rm Ge} = \pm \ 15V$ $I_{\rm C} = 300$ $I_{\rm C} = 25^{\circ}{\rm C}$ $I_{\rm C} = 125^{\circ}{\rm C}$

Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs. Gate Resistance



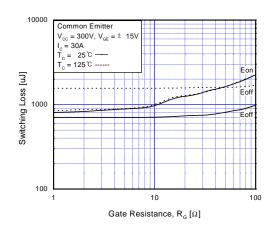
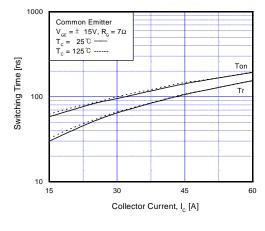


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



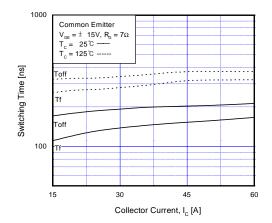
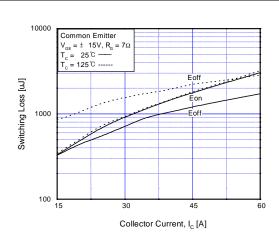


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs. Collector Current



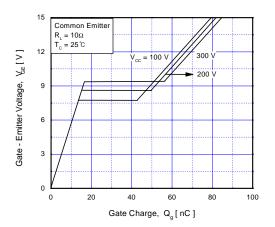
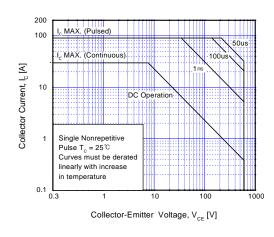


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



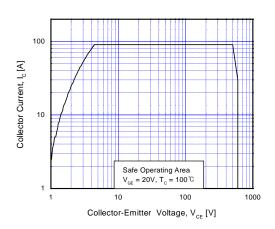


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

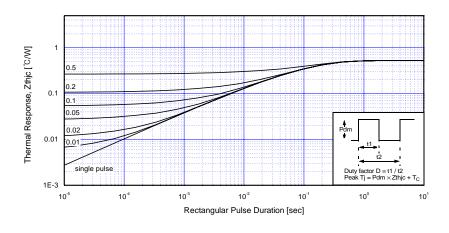
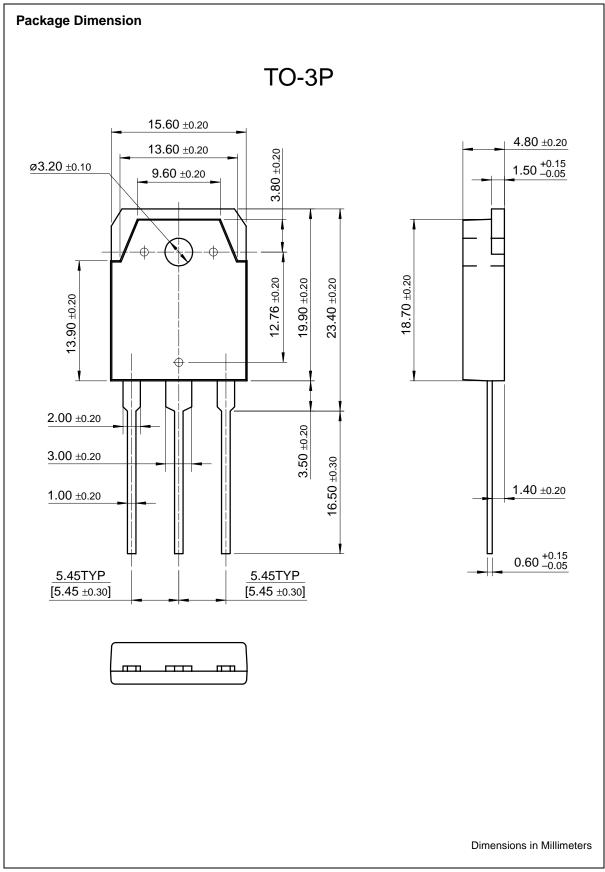


Fig 17. Transient Thermal Impedance of IGBT



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